

## **Product Specification**

Part No.: SCJ-0354

1) Rating: DC 30V 0.3A

2) Operating Temperature Range:  $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$ 

## 3) Electrical Performance:

	Test Conditions	Performance		
Contact Resistance	Measured at small current (10mA	50mΩ Max.		
	1000Hz or less)			
	Apply a voltage of 500V DC			
	shall be applied for 1 minute after			
	which measurement taken:			
	(1) Between terminals not to			
Insulation Resistance	be contact	100MΩ Min.		
	(2) Between body and	TOOMIS2 WIIII.		
	terminal			
	(3) Between terminals not to			
	be contact when plug is			
	inserted			
Dielectric Strength	AC500V rms (50-60Hz) for 1	Without damage to parts arcing		
	minute trip current: 0.5mA			
	(1) Between terminals not to			
	be contact.			
	(2) Between body and			
	terminal	or breakdown		
	(3) Between terminals not to			
	be contact when plug is			
	inserted.			

## 4) Mechanical Performance:

	Test Conditions	Performance
Insertion Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	800~3000 gf
Extraction Force	Measurement shall be made after 3 times of insertion and extraction with gauge plug	400~1500 gf
Terminal Strength	A static load of 150gf shall be applied to the terminal for 15 seconds in any direction	Electrical characteristics shall be satisfied without damage or excessive looseness of terminals
Life Test	Endurance without load: Jack shall be subjected to 5,000 cycles at a rate of 15 to 18 cycles per minute without loading.	<ul> <li>(1) Contact resistance: 100mΩ         Max.</li> <li>(2) Insulation Resistance: 50MΩ         Min.</li> <li>(3) Withstand Voltage: AC 500V</li> </ul>



	(4)	for 1 minute. Without damage to parts
		arcing or breakdown.

## **Environmental Characteristics:** 5)

5) Environmental Characteristics:						
	Test Conditions	Performance				
Solderability Test	The top of terminals shall be	The Area of soldering should be				
	dipped 2mm in the solder bath of	over 75%				
	260±5°C for 3±0.5 seconds					
	Solder bath method:					
	Solder temperature 260±5°C					
	Immersion time 3±0.5 sec.	Without deformation of case or				
	Immersion depth up to the	excessive looseness of terminals				
Resistance to Solder Heat Test	surface of the board 1.6mm	electrical characteristics shall be				
	Dimensions of component holes	satisfied.				
	in the printed wiring board shall	sausneu.				
	be accordance with those					
	specified in this specification.					
	The jack shall be stored at a					
	temperature of -25± 3°C for 48					
	hours, then the switch shall be					
Cold Test	maintained at standard					
	atmospheric conditions for 1 hour					
	after which measurement shall be					
	made	There shall be no deformation or				
	The jack shall be stored at a	cracks in the molded part.				
	temperature of 70±2°C for 48					
	hours, then the jack shall be					
Heat Test	maintained at standard					
	atmospheric conditions for 1 hour					
	after which measurement shall be					
	made.					
Humidity Test	The jack shall be stored at a					
	temperature of 40±2°C and a					
	humidity of 90% to 98% for 48					
	hours, then the jack shall be	There shall be no deformation or				
	maintained at standard	cracks in molded part.				
	atmospheric conditions for 1 hour					
	after which measurement shall be					
	made.					
Te	est Condition (Unless otherwise specifi	ied)				
	Temperature: 5°C - 35°C					
	Humidity: 45% - 85% R.H.					
	Pressure: 86 – 106kPa					